

# SLOVENSKI STANDARD oSIST prEN IEC 60691:2022

01-marec-2022

# Termični taljivi vložki - Zahteve in navodilo za uporabo

Thermal-links - Requirements and application guide

Temperatursicherungen - Anforderungen und Anwendungshinweise

Protecteurs thermiques - Exigences et guide d'application

Ta slovenski standard je istoveten z: prEN JEC 60691:2022 (Standards.iten.al)

ICS:oSIST prEN IEC 60691:2022https://standards.iteh.ai/catalog/standards/sist/cd99db66-29.120.50Varovalke in druga-31dcceff9fafFusespandiother@vercurrent<br/>nadtokovna zaščitaprotection devices

PREV

oSIST prEN IEC 60691:2022

en,fr,de

oSIST prEN IEC 60691:2022

# iTeh STANDARD PREVIEW (standards.iteh.ai)

oSIST\_prEN\_IEC\_60691:2022 https://standards.iteh.ai/catalog/standards/sist/cd99db66-8fff-4cde-a2dc-31dcceff9faf/osist-pren-iec-60691-2022



# 32C/598/CDV

# COMMITTEE DRAFT FOR VOTE (CDV)

PROJECT NUMBER:	
IEC 60691 ED5	
DATE OF CIRCULATION:	CLOSING DATE FOR VOTING:
2022-01-28	2022-04-22
SUPERSEDES DOCUMENTS:	
32C/579A/CD, 32C/595/CC	

IEC SC 32C : MINIATURE FUSES				
SECRETARIAT:	SECRETARY:			
China	Mr Jianqiang Zou			
OF INTEREST TO THE FOLLOWING COMMITTEES:	PROPOSED HORIZONTAL STANDARD:			
	Other TC/SCs are requested to indicate their interest, if any, in this CDV to the secretary.			
FUNCTIONS CONCERNED:	ΝΠΑΡΠ			
	QUALITY ASSURANCE SAFETY			
SUBMITTED FOR CENELEC PARALLEL VOTING	<b>NOT SUBMITTED FOR CENELEC PARALLEL VOTING</b>			
Attention IEC-CENELEC parallel voting and ards.iteh.ai)				
The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting. <u>prEN IEC 60691:2022</u> <u>https://standards.iteh.ai/catalog/standards/sist/cd99db66-</u>				
The CENELEC members are invited to yote through the CENELEC online voting system.	E/osist-pren-iec-60691-2022			

This document is still under study and subject to change. It should not be used for reference purposes.

Recipients of this document are invited to submit, with their comments, notification of any relevant patent rights of which they are aware and to provide supporting documentation.

### TITLE:

### Thermal-links - Requirements and application guide

PROPOSED STABILITY DATE: 2024

## NOTE FROM TC/SC OFFICERS:

The markup of changes indicate the revision compared to the CD document (32C/579A/CD).

**Copyright** © **2021 International Electrotechnical Commission, IEC**. All rights reserved. It is permitted to download this electronic file, to make a copy and to print out the content for the sole purpose of preparing National Committee positions. You may not copy or "mirror" the file or printed version of the document, or any part of it, for any other purpose without permission in writing from IEC.

- 2 - IEC CDV 60691:2021© IEC 2021

# CONTENTS

1

2	FOREWO	DRD	4
3	INTROD	JCTION	6
4	1 Scop	De	7
5	2 Norr	native references	7
6	3 Tern	ns and definitions	8
7	4 Gen	eral requirements	
8		eral notes on tests	
9		sification	
10	6.1	Electrical conditions	
11	6.2	Thermal conditions	
12	6.3	Resistance to tracking	
13	7 Marl	دing	
14	8 Doci	umentation	
15	9 Con	structional requirements	
16	9.1	General	
17	9.2	Lead secureness testsehSTANDARD	
18	9.2.1	1 General	
19	9.2.2	1 General	
20	9.2.3		
21	9.2.4		16
22	9.3	Contacts used for the current path	17
23	9.4	Accessible mounting brackets or metal parts 1:2022	18
24	9.5	Insulating materials dards.iteh.ai/catalog/standards/sist/cd99db66	18
25	9.6	Resistance to tracking to 31 dcceff9 faf/osist-pren-iec-60691-2022	18
26	9.7	Creepage distances and clearances	
27	9.8	Temperature and humidity cycle conditioning	
28	9.9	Terminals and terminations	
29		trical requirements	
30	10.1	Dielectric strength	
31	10.2 10.3	Insulation resistance	
32 33	10.3	Interrupting current	
33 34	10.3		
35	10.4	Transient overload current	
36	10.5	Limited short-circuit test	
37	10.5		
38	10.5		
39	10.5	.3 Fuse size (rating)	24
40	10.5	.4 Compliance	24
41	11 Tem	perature tests	24
42	11.1	General	24
43	11.2	Holding temperature, <i>T</i> <sub>h</sub>	25
44	11.3	Rated functioning temperature, <i>T</i> f	
45	11.4	Maximum temperature limit, <i>T</i> <sub>m</sub>	25

# IEC CDV 60691:2021© IEC 2021 - 3 -

46	11.5 Ageing	26
47	12 Resistance to rusting	26
48	13 Manufacturer's validation programme	27
49	Annex A (normative) Application guide	28
50	Annex B (normative) Alternative ageing test for thermal-links with $T_h$ greater than	
51	250 °C for use in electric irons	
52	Annex C (normative) Conductive heat ageing test	
53	C.1 Conductive heat ageing test	
54	C.2 Method	
55	C.3 Ageing	
56	C.4 Results C.5 Dielectric strength test	
57 59	C.5 Dielectric strength test C.6 Test oven	
58 59	Annex D (informative) Extended holding temperature evaluation	
	D.1 Extended holding temperature conditioning test	
60 61	D.2 Load current interrupt test	
62	Annex E (normative) Seal ageing test	
63	Annex F (normative) Identification requirements	
64	Annex G (normative) Indelibility of markings A.N.D.A.R.D.	
65	Annex H (normative) Requirements for thermal-link packaged assemblies	
	Bibliography	
66 07		
67	Figure 1 – Bending/twist test	47
68		
69	Figure C.1 – Typical test fixture assembly <u>SIST prEN IEC 60691:2022</u> Figure C.2 – Typical thermal-link test oven <u>https://standards.iteh.ai/catalog/standards/sist/cd99db66</u> -	32
70	Figure C.2 – Typical thermal-link test oven https://standards.iteh.ai/catalog/standards/sist/cd99db66-	33
71	Figure D.1 – Typical terminal block support test fixturepren-icc-60691-2022	35
72	Figure E.1 – Conditioning time versus oven temperature for proposed temperature index	27
73		
74	Figure G.1 – Apparatus for testing durability of markings	39
75		
76	Table 1 – Test schedule	12
77 78	Table 2 – Strength of leads and terminal parts – Minimum required tensile and thrust test forces.	17
79	Table 3 – Creepage distances and clearances (absolute minimum values)	19
80	Table 4 – Test voltages for dielectric strength	20
81	Table 5 – Test current for interrupting test	21
82	Table 6 – Limited short-circuit test capacity	
83	Table H.1 – Push and pull force	
84	Table H.2 – Minimum nominal cross-sectional area of conductor	
85		

- 86

- 4 -

IEC CDV 60691:2021© IEC 2021

87		INTERNATIONAL ELECTROTECHNICAL COMMISSION
88		
89		
90		THERMAL-LINKS –
91		REQUIREMENTS AND APPLICATION GUIDE
92		
93		FOREWORD
94 95 96 97 98 99 100 101 102 103	1)	The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
104 105 106	2)	The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
107 108 109 110	3)	IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
111 112 113 114	4)	In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
115 116 117	5)	IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
118	6)	All users should ensure that they have the latest edition of this publication. https://standards.iteh.al/catalog/standards/sist/cd99db66-
119 120 121 122 123	7)	No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
124 125	8)	Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
126 127	9)	Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.
	T u	DISCLAIMER This Consolidated version is not an official IEC Standard and has been prepared for user convenience. Only the current versions of the standard and its amendment(s) re to be considered the official documents.
128 129 130 131	fo co	nis Consolidated version of IEC 60691 bears the edition number 4.1. It consists of the urth edition (2015-10) [documents 32C/512/FDIS and 32C/515/RVD] and its prrigendum (2016-08), and its amendment 1 (2019-01) [documents 32C/548/FDIS and CC/559/RVD]. The technical content is identical to the base edition and its amendment.

In this Redline version, a vertical line in the margin shows where the technical content
 is modified by amendment 1. Additions are in green text, deletions are in strikethrough
 red text. A separate Final version with all changes accepted is available in this
 publication.

- 136
- 137

IEC CDV 60691:2021© IEC 2021 - 5 -

- International Standard IEC 60691 has been prepared by subcommittee 32C: Miniature fuses,
  of IEC technical committee 32: Fuses.
- 140 This fifth edition constitutes a technical revision.
- 141 This fifth edition includes the following significant technical changes with respect to the 142 previous edition:
- a) requirements for thermal-link packaged assemblies;
- b) renew the requirements and definitions for  $T_{\rm h}$ -test;
- 145 This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.
- 146 The basis for this standard is the harmonization of the USA national standard, UL 1020, fifth
- edition (withdrawn 2003), and IEC 60691:1993, together with its Amendment 1:1995 and Amendment 2:2000.
- The following differing practices of a less permanent nature exist in the country indicated below:
- 151 Annex C is required to be declared in the USA; A R D
- 152 Annex E is required in the USA, if applicable;
- 153 Annex F is required to be declared in the USA.

154 In this standard, the following type is used ards.iteh.ai)

155 – compliance statements: in italic type.

The committee has decided that the contents of the base publication and its amendment will remain unchanged truntistathear stability / date gindicated s/ont/the diffe- web site under "http://webstore.iec.ch"-in dthe 2 data related fto the specific - publication? At this date, the publication will be

- reconfirmed,
- 161 withdrawn,
- replaced by a revised edition, or
- 163 amended.
- 164

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

# - 6 -

IEC CDV 60691:2021© IEC 2021

# INTRODUCTION

167 Thermal-links, defined as non-resettable devices functioning once only without refunctioning, 168 are widely applied for the thermal protection of equipment in which, under fault (abnormal) 169 conditions, one or more parts may reach hazardous temperatures.

As these devices have several aspects in common with miniature fuse-links and are used for obtaining a comparable degree of protection, this standard has endeavoured to lay down a number of basic requirements for such devices.

173

166

174

# iTeh STANDARD PREVIEW (standards.iteh.ai)

oSIST prEN IEC 60691:2022 https://standards.iteh.ai/catalog/standards/sist/cd99db66-8fff-4cde-a2dc-31dcceff9faf/osist-pren-iec-60691-2022

#### IEC CDV 60691:2021© IEC 2021 -7-

#### THERMAL-LINKS -175 **REQUIREMENTS AND APPLICATION GUIDE** 176

177

178 179

#### 1 Scope 180

This International Standard is applicable to thermal-links intended for incorporation in 181 electrical appliances, electronic equipment and component parts thereof, normally intended 182 for use indoors, in order to protect them against excessive temperatures under abnormal 183 conditions. 184

NOTE 1 The equipment is not designed to generate heat. 185

NOTE 2 The effectiveness of the protection against excessive temperatures logically depends upon the position 186 187 and method of mounting of the thermal-link, as well as upon the current which it is carrying.

This standard may be applicable to thermal-links for use under conditions other than indoors, 188 provided that the climatic and other circumstances in the immediate surroundings of such 189 thermal-links are comparable with those in this standard. 190

191 This standard may be applicable to thermal-links in their simplest forms (e.g. melting strips or wires), provided that molten materials expelled during function cannot adversely interfere with 192 the safe use of the equipment, especially in the case of hand-held or portable equipment, 193 irrespective of its position. 194 K H) H,

Annex H of this standard is applicable to thermal-link packaged assemblies where the 195 thermal-link(s) has already been approved to this standard but packaged in a metallic or non-196 metallic housing and provided with terminals/wiring leads. 197

This standard is applicable to thermal-links with a rated voltage not exceeding 690 V AC or 198 DC and a rated current not exceeding 63 A DC and a rated current not exceeding 63 A 199

- The objectives of this standard are: 200
- a) to establish uniform requirements for thermal-links, 201
- b) to define methods of test, 202
- c) to provide useful information for the application of thermal-links in equipment. 203
- 204 This standard is not applicable to thermal-links used under extreme conditions such as corrosive or explosive atmospheres. 205
- This standard is not applicable to thermal-links to be used in circuits on a.c. with a frequency 206 lower than 45 Hz or higher than 62 Hz. 207

#### 2 **Normative references** 208

The following documents, in whole or in part, are normatively referenced in this document and 209 are indispensable for its application. For dated references, only the edition cited applies. For 210 undated references, the latest edition of the referenced document (including any 211 amendments) applies. 212

IEC 60065:2014, Audio, video and similar electronic apparatus – Safety requirements 213

### - 8 -

IEC CDV 60691:2021© IEC 2021

IEC 60112:2003, Method for the determination of the proof and the comparative tracking

- 214 IEC 60112:2003, *Method for the c* 215 *indices of solid insulating materials*
- 216 IEC 60112:2003/AMD1:2009
- 217 IEC 60127-2:2014, Miniature fuses Part 2: Cartridge fuse-links
- IEC 60216-5:2008, Electrical insulating materials Thermal endurance properties Part 5: Determination of relative thermal endurance index (RTE) of an insulating material
- IEC 60664-1:2007, Insulation coordination for equipment within low-voltage systems Part 1:
  Principles, requirements and tests
- IEC 60695-2-12:2010, Fire hazard testing Part 2-12: Glowing/hot-wire based test methods –
- 223 Glow-wire flammability index (GWFI) test method for materials
- 224 IEC 60695-2-12:2010/AMD1:2014
- IEC 60695-2-13:2010, Fire hazard testing Part 2-13: Glowing/hot-wire based test methods –
- 226 Glow-wire ignition temperature (GWIT) test method for materials
- 227 IEC 60695-2-13:2010/AMD1:2014
- IEC 60695-10-2:2014, Fire hazard testing Part 10-2: Abnormal heat Ball pressure test method
  - iTeh STANDARD
- IEC 60695-11-10:2013, Fire hazard testing Part 11-10: Test flames 50 W horizontal and
  vertical flame test methods
- IEC 60730-1:2015, Automatic electrical controls Part 1: General requirements
- IEC 61210:2010, Connecting devices Flat quick-connect terminations for electrical copper
  conductors Safety requirement<u>sSIST prEN IEC 60691:2022</u>

https://standards.iteh.ai/catalog/standards/sist/cd99db66-

- **3** Terms and definitions<sup>a2dc-31dcceff9faf/osist-pren-iec-60691-2022</sup>
- For the purposes of this document, the following terms and definitions apply.
- 237 **3.1**
- 238 clearance
- shortest distance in air between two conductive parts
- 240 **3.2**
- 241 creepage distance
- shortest distance along the surface of insulating material between two conductive parts
- 243 **3.3**

# 244 holding temperature

- 245 T<sub>h</sub>
- 246 maximum ambient temperature of the thermal-link at which it will not change its state of 247 conductivity during a specified time at a specified rated current

### 248 **3.4**

# 249 homogeneous series

- series of thermal-links having the same external dimensions and common overall construction,
- deviating from each other only in such characteristics (including ratings) that, for a given test,
- the testing of one or a reduced number of particular thermal-links of that series shall be taken
- as representative for all the thermal-links of the series

#### IEC CDV 60691:2021© IEC 2021 -9-

254 3.5

#### interrupting current 255

256  $I_{\mathsf{b}}$ 

value of the current that the thermal-link is capable of interrupting at rated voltage and under 257 specified circuit conditions 258

#### 3.6 259

#### maximum temperature limit 260

- 261  $T_{\rm m}$
- temperature of the thermal-link stated by the manufacturer, up to which the mechanical and 262 electrical properties of the thermal-link, having changed its state of conductivity, will not be 263 impaired for a given time 264

#### 265 3.7

pilot duty 266

3.9

rating assigned to a switching device that controls the coil of another electro-mechanical 267 device such as a solenoid, relay or contactor 268

#### 3.8 269

273

274

275 276

#### portable equipment 270

rated current

- equipment which is moved while in operation or which can easily be moved from one place to 271 another while connected to the supply 272
  - **iTeh STANDARD** current used to classify a thermal-link (standards.iteh.ai)
- 277 3.10

#### rated functioning temperature 278

- 279
- $T_{\rm f}$  temperature of the thermal-link which causes it to change its state of conductivity with a 280 281
- detection current up to 10 mA as the only load 8fff-4cde-a2dc-31dcceff9faf/osist-pren-iec-60691-2022
- 3.11 282
- rated voltage 283
- 284  $U_{\mathsf{r}}$
- voltage used to classify a thermal-link 285

#### 3.12 286

#### thermal element 287

metallic or non-metallic fusible material that is part of a thermal-link and is responsive to 288 temperature by a change of state such as from solid to liquid at the temperature for which it is 289 calibrated 290

#### 291 3.13

- thermal-link 292
- non-resettable device incorporating a thermal element, which will open a circuit once only 293 294 when exposed for a sufficient length of time to a temperature in excess of that for which it has been designed 295

#### 3.14 296

#### transient overload current 297

- 298
- direct current pulse train which the thermal-link is able to withstand without impairing its 299 characteristics 300

- 10 -

#### 301 3.15

#### extended holding temperature 302

303  $T_{h-100}$ 

maximum temperature at which a thermal-link can be maintained while conducting the rated 304 current at the rated voltage for a period of 100 weeks which will not cause the thermal-link to 305 open circuit in accordance with extended holding temperature evaluation 306

- 307 Note 1 to entry: This is a rating for user consideration during the investigation of the end product.
- 308 Note 2 to entry: Annex D specifies the extended holding temperature evaluation.
- 309 3.16

#### conductive heat ageing test 310

- CHAT 311
- test to evaluate a thermal-link for use in an appliance 312
- 313 Note 1 to entry: If it performs satisfactorily, the thermal-link will be assigned a CHAT rating. This rating is for end-314 product user consideration during the investigation of the end-use product.
- 315 Note 2 to entry: Annex C specifies the conductive heat ageing test.

#### **General requirements** 316 4

Adequate protection of the equipment against excessive temperatures not only 317 4.1 depends upon the properties of the thermal-link but also to a large extent upon the mounting 318 of the thermal-link in the equipment. Therefore, in addition to good engineering practice, the 319 requirements of the application guide in Annex A shall be considered. 320

321 4.2 Thermal-links shall have adequate electrical and mechanical strength and shall be constructed so as to withstand all conditions of handling likely to be encountered during 322 mounting and normal use, when used within the requirements of this standard. 323

**4.3** When a thermal-link changes its state of conductivity, no arc or flame shall be maintained, nor material expelled, that might impair the surrounding area or otherwise create 324 325 a risk of electric shock of fire. In addition, there shall be no emission of substances (e.g. 326 gases, liquids, dust, mist, vapour) which could cause a hazard. 327

For thermal-links using melting strips or wires, care should be taken to prevent molten 328 material from short-circuiting or bridging creepage distances and clearances in air, so as to 329 reduce the risk of impairing the insulation system of the equipment. 330

After it has functioned, the thermal-link shall not be damaged when subjected to temperatures 331 not exceeding  $T_{\rm m}$ , in such a way that the safety of the equipment with regard to risk of electric 332 shock hazard and electrical breakdown is impaired. The thermal-link shall not reclose after it has 333 operated. 334

For requirements for thermal-link packaged assemblies, see Annex H. 335 4.4

#### General notes on tests 5 336

5.1 The test conditions are as follows. 337

338 5.1.1 Unless otherwise specified, only tests that are not required to be performed inside an environmental chamber and/or test oven shall be carried out under the following atmospheric 339 conditions: 340

- temperature: 15 °C to 35 °C, 341 \_
- relative humidity: 25 % to 75 %, 342 —

## IEC CDV 60691:2021© IEC 2021 - 11 -

343 – air pressure:  $8,6 \times 10^4$  Pa to  $1,06 \times 10^5$  Pa.

The required atmospheric conditions during testing can be controlled when carrying out the tests and during the duration of the tests. The required atmospheric conditions do not have to be maintained in a test laboratory when tests are not performed.

**5.1.2** Where the conditions given in 5.1.1 have a significant influence, they shall be kept substantially constant during the tests.

**5.1.3** If the temperature limits given in 5.1.1 are too wide for certain tests, these shall be repeated, in case of doubt, at a temperature of  $(23 \pm 1)$  °C.

**5.2** In every test report, the ambient temperature shall be stated. If the standard conditions for relative humidity or pressure are not fulfilled during the tests, a note to this effect shall be added to the report.

**5.3** If the result of a test is influenced, to an appreciable extent, by the position and method of mounting of the specimen, the most unfavourable condition shall be chosen for the relevant tests and recorded.

**5.4** If a thermal-link has been specifically designed for use in a special type of equipment and cannot be tested separately, the tests of this standard shall be performed in that equipment or in the relevant part of it, or similar.

**5.5** When testing a homogeneous series of thermal-links, all the tests shall be applied to thermal-links with the lowest and highest  $T_{f_1}$ . Thermal-links with intermediate rated functioning temperatures need only be subjected to tests according to 10.3, 11.3, 11.4 and 11.5.

363 5.6 The number of specimens is as follows: ds.iteh.ai)

**5.6.1** The total number of specimens required is 48. Out of a total of 48 specimens, 15 are kept as spares in case some of the tests have to be repeated. Out of a total of 48 specimens, 36 33 are divided into the groups assigned by alphabetical setters from A-to K. Each group consists of three specimens. Tests shall be performed in the order indicated in Table 1 but, if so required, tests may be repeated, for example the test on marking (see Clause 7). Additional specimens may be needed according to Note 2 of Table 1.

For optional tests, additional specimens should be required as per the applicable annexes.

**5.6.2** If, in any of the tests carried out in accordance with any relevant test clause, a failure is reported, the cause of the failure will be identified and corrective action taken. Based on the failure analysis report and the corrective action, as a minimum, the test sequence shall be repeated on twice the number of revised specimens, and no further failures are allowed.

- If no corrective actions are necessary, the test should be repeated with double the same sizeand no further deviation is allowed.
- **5.6.3** For requirements for thermal-link packaged assemblies, see Annex H
- **5.7** The conductive heat ageing test of Annex C is applicable when declared by the manufacturer.

The conductive heat ageing test may be omitted if the thermal-link is constructed without contacts.

382 NOTE In the USA the conductive heat ageing test is required to be declared.